

PIN 1,2 & 3,4 must be connected on PCB

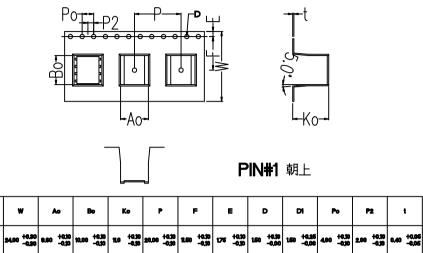
## **ELECTRICAL CHARACTERISTICS:**

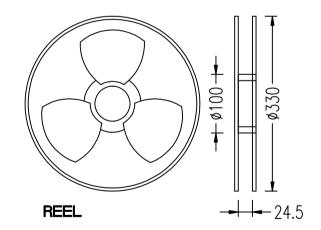
- 1. DCR : PIN  $2-3 = 0.1\Omega$  MAX. (1-2, 3-4 SHORT)PIN  $8-5 = 0.55\Omega$  MAX.
- 2. INDUCTANCE (@10kHz, 0.1Vrms) PIN 2-3 (1-2, 3-4 SHORT) =  $2uH \pm 5\%$
- 3. LEAKAGE INDUCTANCE (@100kHz, 0.1Vrms) PIN 2-3 (PIN 8-7, 1-2, 3-4 SHORT) = 0.1uH MAX.
- 4. TURN RATIO (@10kHz, 0.1Vrms) PIN 8-5 :  $2-3 = 10 : 1 \pm 2\%$  (1-2, 3-4 SHORT)
- 5. HI-POT (@1875Vrms, 0.5mA, 1SEC): PIN 1-2 TO 8
- 6. RoHS COMPLIANT

Unit:mm

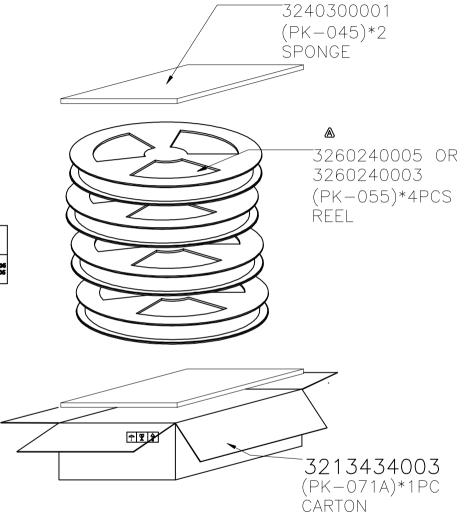
									TITLE DWG. N	FLYBACK TRANSFORMER io. ATS-1139R
Ī		RELEASE	04/13 /2012	SHIRLEY	BETTY	BETTY	UNITS: M/M	SAFETY		SHEET 1 OF 1
	NO:	DESCRIPTION	DATE	BY	СНК	APPD	,	P/N:		DRAW
	REVISIONS						04/13/12			SHIRLEY







**毎絶放影機** 1pc 用真空袋抽真空封口 2780000000 3255048420 ONE REEL 300 PCS ONE CARTON 4 REEL (1200 PCS)



						$\wedge$ $\wedge$	<u> </u>	TITLE	PACKING
A	CHANGE PART NO.	09/21 /2011	SHIRLEY	JOAN	JOAN			DWG. N	o. 968TS66100
	RELEASE	11/03 /2006	PAIR	WILLIE	EUGENE	UNITS: M/M	SAFETY		SHEET 1 OF 1
NO:	DESCRIPTION	DATE	BY	СНК	APPD	,	P/N:		DRAW
	REVI		11/03/06			Shirley			



## Pb-free Soldering IR Reflow(SMD)



1,MSL Grade: 1 Level 2,Floor life: 2years 3,Condition:≤30°C RH 85% 2,Form-1(Reference JEDEC J-STD-020D Table 5-2)

	IR reflow profile	Pb-free		
step#	Profile Feature	Condition/Duration		
step1	Ramp-up rate	3°C/second max		
step2	Preheat:150°C-200°C(Ta-Tb)	t1-t2:60-120seconds		
step3	Ramp-up rate(TL to Tp)	3°C/second max		
sieps	Temperature maintained above 217°C	60-150seconds		
ston/	Peak temperature(Tp)	260+0/-5°C		
step4	Time within 5°C of actual peak temperature	30seconds max		
	Ramp-down rate(Tp to TL)	6°C/second max		

## 3,Form-2(Reference JEDEC J-STD-020D Table 4-2)

Package	Volume mm <sup>3</sup>	Volume mm <sup>3</sup>	Volume mm <sup>3</sup>
Thickness	<350	350-2000	>2000
<1.6mm	260+0/-5°C	260+0/-5°C	260+0/-5℃
1.6mm-2.5mm	260+0/-5°C	250+0/-5°C	245+0/-5℃
>2.5mm	250+0/-5° <b>C</b>	245+0/-5°C	245+0/-5℃